

ELECTRICAL CHARACTERISTICS ($T_j=25$ unless otherwise specified)

Symbol	Test Condition	Quadrant	Value		Unit
I_{GT}	$V_D=12V R_L=33$	ALL	MAX.	5	mA
V_{GT}		ALL	MAX.	1.3	V
V_{GD}	$V_D=V_{DRM} T_j=125$ $R_L=3.3k$	ALL	MIN.	0.2	V
I_L	$I_G=1.2I_{GT}$	- -	MAX.	9	mA
				13	
I_H	$I_T=100mA$		MAX.	5	mA
dV/dt	$V_D=400V$ Gate Open $T_j=110$		MIN.	30	$V/\mu s$
$(dV/dt)_c$	$(dI/dt)_c=1.8A/ms, T_j=110$		MIN.	1.2	$V/\mu s$
t_{on}	$I_G=10mA I_A=200mA I_R=20mA$ $T_j=25$		TYP.	2	μs
t_{off}				20	

STATIC CHARACTERISTICS

Symbol	Parameter		Value(MAX.)	Unit
V_{TM}	$I_{TM}=5A t_p=380\mu s$	$T_j=25$	1.55	V
V_{TO}	Threshold voltage	$T_j=125$	0.92	V
R_D	Dynamic resistance	$T_j=125$	107	m
I_{DRM}	$V_D=V_{DRM} V_R=V_{RRM}$	$T_j=25$	5	μA 107

FIG.1: Maximum power dissipation versus RMS on-state current

FIG.2: RMS on

FIG.7: Relative variations of gate trigger current, holding current and latching current versus junction temperature

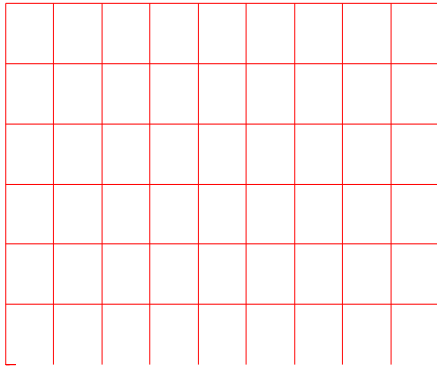
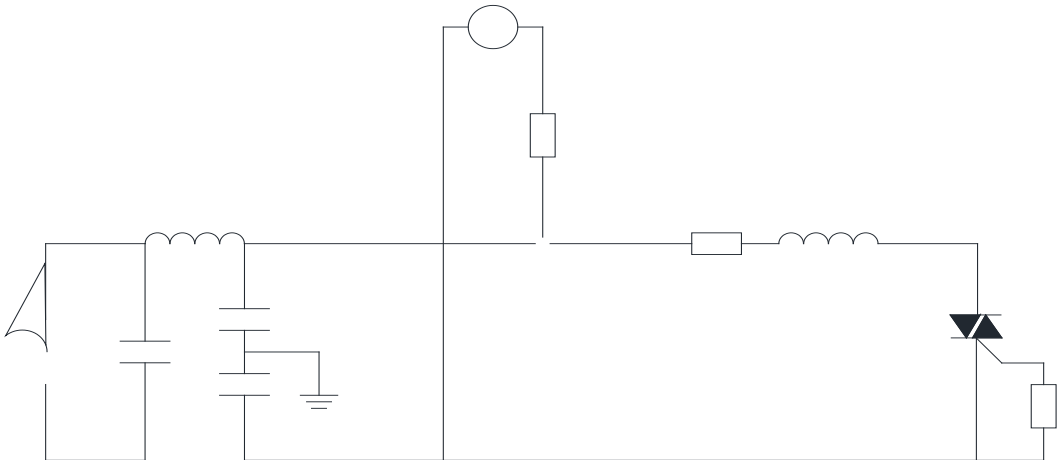


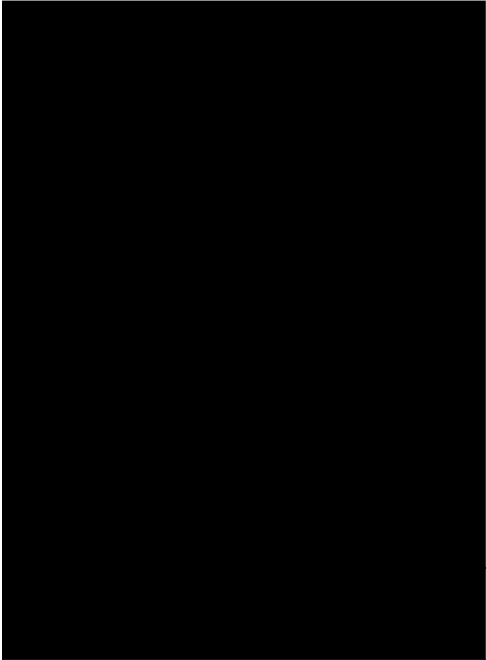
Figure 7 is a blank grid for plotting data.

FIG.8 Test circuit for inductive and resistive loads to IEC-61000-4-5 standards





IGT(mA)	Package	Base qty. (pcs)	




PACKAGE MECHANICAL DATA

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	1.50		1.80	0.059		0.071
					0.002	
	2.90		3.10	0.114		0.122
	0.60		0.80	0.024		0.031
	0.22		0.32	0.009		0.013
	6.30		6.70	0.248		0.264
	3.30		3.70	0.130		0.146
H	1.50					
J	6.70		7.30	0.264		0.287

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